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**Part Number:** **0747500303**  
**Status:** **Active**  
**Overview:** QSFP+ Interconnect Solution  
**Description:** Quad Small Form-factor Pluggable Plus (QSFP+) PCI Heat Sink for 1x1 PCI EMI Cages with Spring Fingers

**Documents:**

[Drawing \(PDF\)](#) [Application Specification AS-74750-0001 \(PDF\)](#)  
[Product Specification PS-74750-0002 \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

**General**

Product Family	I/O Connectors
Series	<u>74750</u>
Application	N/A
Component Type	Heatsink
Overview	<u>QSFP+ Interconnect Solution</u>
Product Name	QSFP+
Type	N/A
UPC	883906110185

**Physical**

Circuits (Loaded)	N/A
Durability (mating cycles max)	1
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Nickel
Net Weight	6.230/g
Orientation	N/A
PC Tail Length	2.28mm
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Panel Mount	N/A
Pitch - Mating Interface	N/A
Polarized to Mating Part	N/A
Termination Interface: Style	N/A

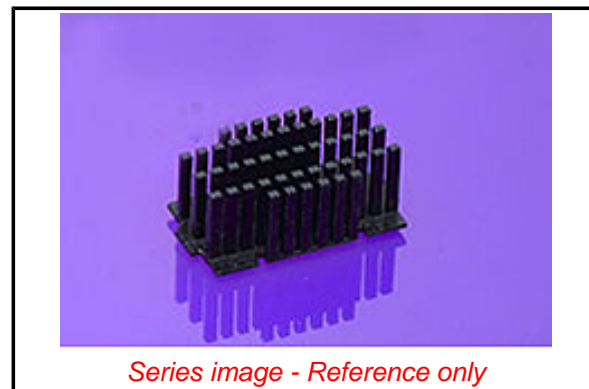
**Electrical**

Current - Maximum per Contact	N/A
Shield Type	N/A

**Material Info**

**Reference - Drawing Numbers**

Application Specification	AS-74750-0001
Product Specification	PS-74750-0002
Sales Drawing	SD-74750-1140



*Series image - Reference only*

**EU ELV**

**Not Relevant**

**EU RoHS**

**Compliant**

**REACH SVHC**

Contains SVHC(2014 December 17): No

**Halogen-Free**

**Status**

**Low-Halogen**

**Need more information on product environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
Please visit the [Contact Us](#) section for any non-product compliance questions.

China ROHS

ELV

Green Image

Not Relevant

**Search Parts in this Series**

74750 Series

**Use With**

74750 QSFP+ Cage Assembly